

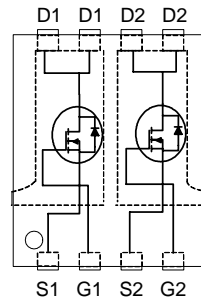


- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic
- ▼ RoHS Compliant & Halogen-Free

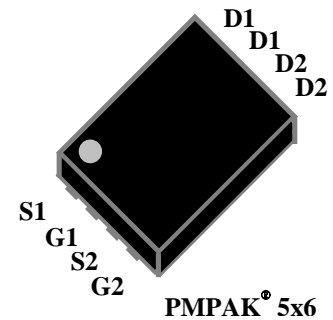
Description

AP3A010 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device fo

PMPAK[®] 5x6 dual pad provide superior thermal performance and is design for surface mount applications.



BV_{DSS}	30V
$R_{DS(ON)}$	10.5m Ω



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	+20	V
$I_D @ T_C = 25^\circ C$	Drain Current, $V_{GS} @ 10V^4$	34	A
$I_D @ T_A = 25^\circ C$	Drain Current, $V_{GS} @ 10V^{3,4}$	14.6	A
$I_D @ T_A = 70^\circ C$	Drain Current, $V_{GS} @ 10V^{3,4}$	11.7	A
I_{DM}	Pulsed Drain Current ¹	80	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	3.57	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Rating	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	6	$^\circ C/W$
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	35	$^\circ C/W$



AP3A010MT

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =14A	-	-	10.5	mΩ
		V _{GS} =4.5V, I _D =10A	-	-	17	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250yA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =14A	-	34	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Q _g	Total Gate Charge	I _D =10A	-	16	25.6	nC
Q _{gs}	Gate-Source Charge	V _{DS} =15V	-	5	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	5.5	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =15V	-	9	-	ns
t _r	Rise Time	I _D =1A	-	9	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω	-	30	-	ns
t _f	Fall Time	V _{GS} =10V	-	7	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1830	2928	pF
C _{oss}	Output Capacitance	V _{DS} =15V	-	180	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	150	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1	2	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =2.9A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time	I _S =14A, V _{GS} =0V,	-	10	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	2.5	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board, t ≤10sec ; 85 °C/W on steady state.
- 4.Package limitation current is 20A .

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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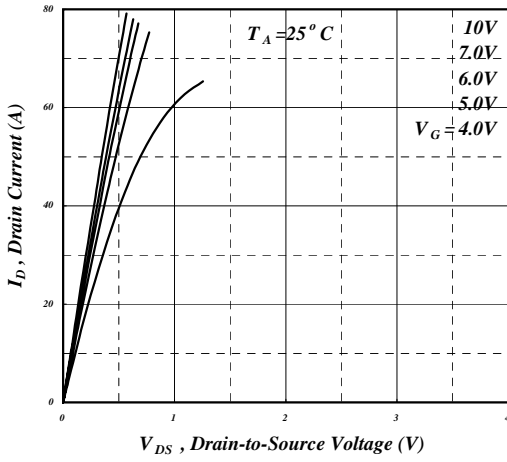


Fig 1. Typical Output Characteristics

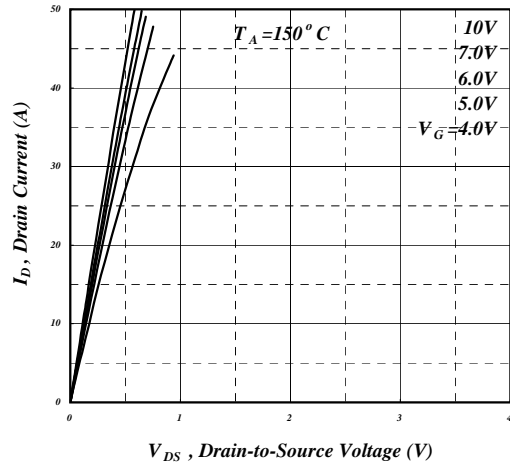


Fig 2. Typical Output Characteristics

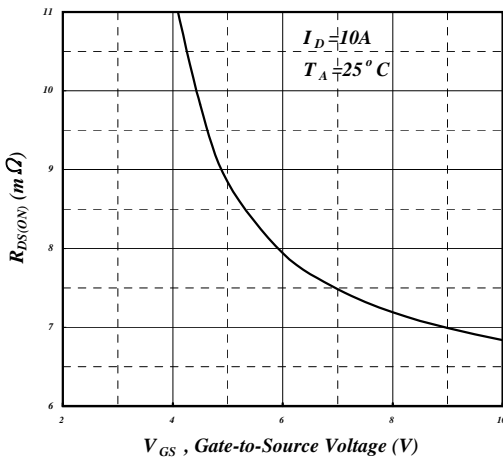


Fig 3. On-Resistance v.s. Gate Voltage

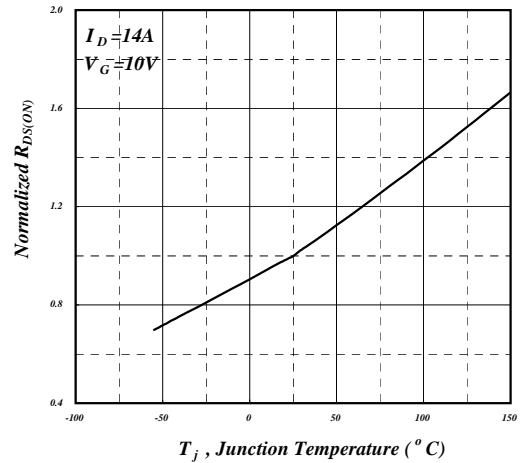


Fig 4. Normalized On-Resistance v.s. Junction Temperature

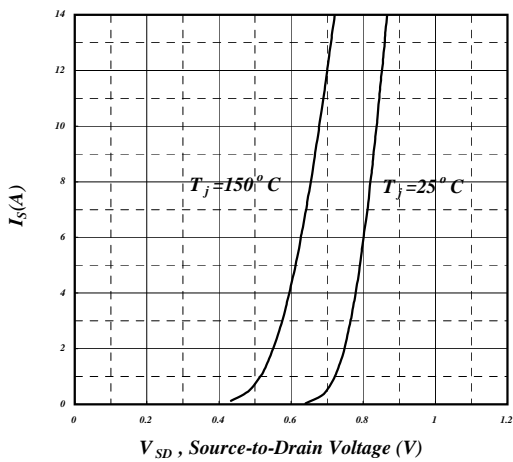


Fig 5. Forward Characteristic of Reverse Diode

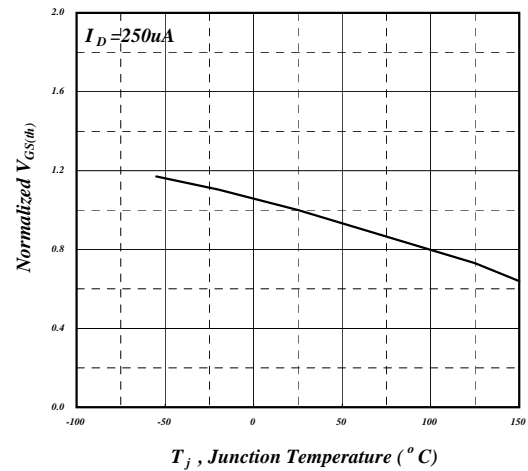


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

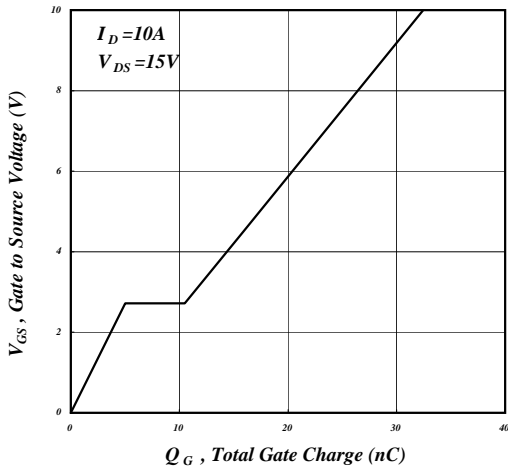


Fig 7. Gate Charge Characteristics

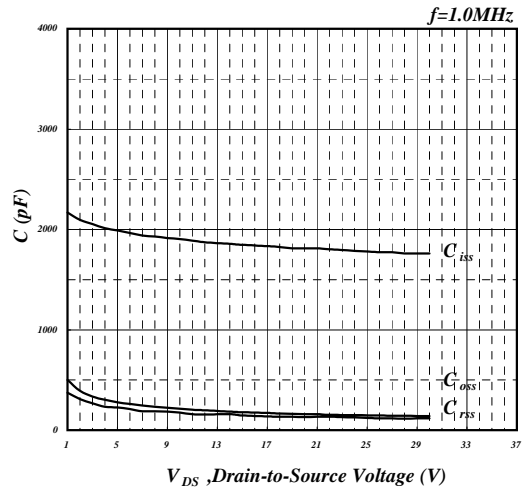


Fig 8. Typical Capacitance Characteristics

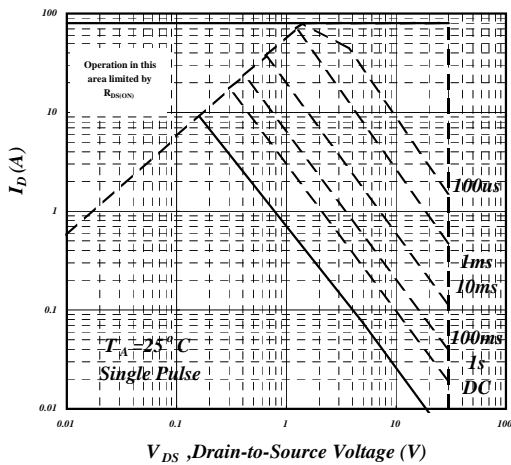


Fig 9. Maximum Safe Operating Area

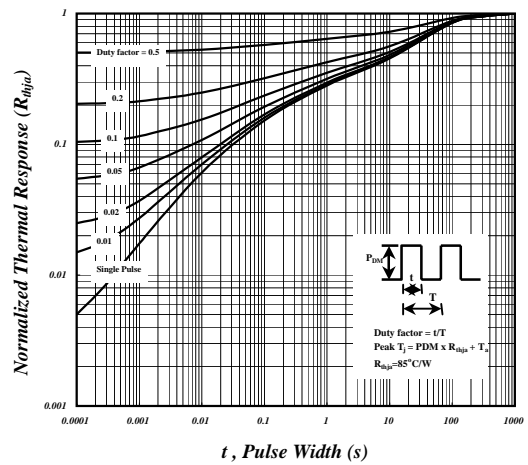


Fig 10. Effective Transient Thermal Impedance

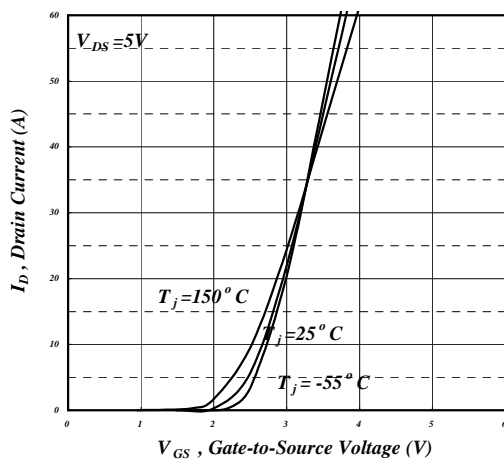


Fig 11. Transfer Characteristics

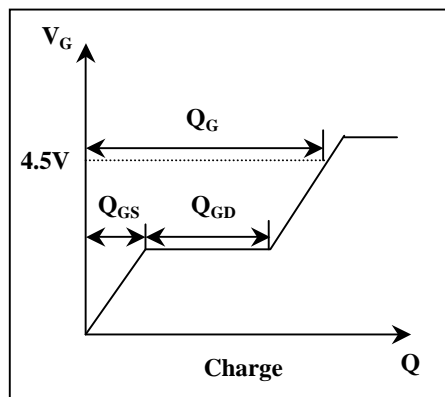
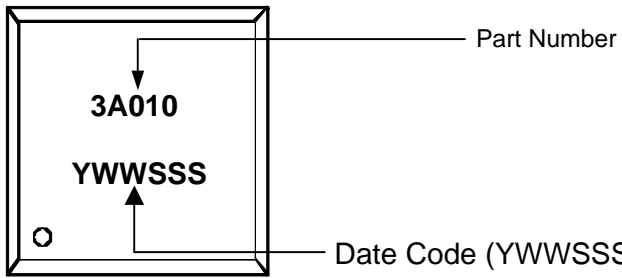


Fig 12. Gate Charge Waveform



MARKING INFORMATION



Y : Last Digit Of The Year
WW : Week
SSS : Sequence